

STS4C3F60L

N-channel 60V - 0.045 Ω - 4A SO-8 Complementary pair STripFETTM Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS4C3F60L(N-channel)	60V	<0.056Ω	4A
STS4C3F60L(P-channel)	60V	<0.120Ω	ЗА

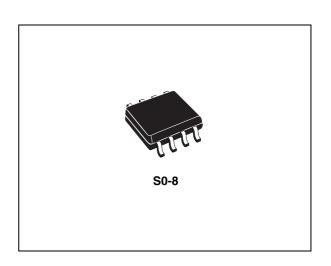
- Standard outline for easy automated surface mount assembly
- Low threshold drive

Description

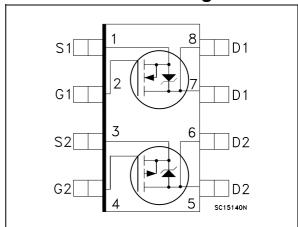
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STS4C3F60L	S4C3F60L	SO-8	Tape & reel

Contents STS4C3F60L

Contents

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STS4C3F60L Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Val	Unit	
		N-channel	P-channel	
V _{DS}	Drain-source voltage (v _{gs} = 0)	60)	V
V _{GS}	Gate- source voltage	±16		٧
I _D	Drain current (continuous) at T _C = 25°C	4	3	Α
I _D	Drain current (continuous) at T _C = 100°C	2.5	1.9	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	16 12		Α
P _{TOT}	Total dissipation at T _C = 25°C	2		W
T _{stg} T _j	Storage temperature Max. operating junction temperature	-55 to 150		°C

^{1.} Pulse width limited by safe operating area

Note: For the P-CHANNEL MOSFET actual polarity of voltages and current has to be reversed

Table 2. Thermal data

thj-a ⁽¹⁾ Thermal resistance junction-ambient	62.5	°C/W	I
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^{1.} When mounted on 1 in 2 pad of 2 oz. copper, $t \le 10$ sec.

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Electrical characteristics STS4C3F60L

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DS}	Drain-source Breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	n-ch p-ch	60 60			V V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} =Max rating, T_{C} =125°C	n-ch p-ch			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±16V	n-ch p-ch			±100 ±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	n-ch p-ch	1 1.5			V V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 2A$ $V_{GS} = 10V, I_D = 1.5A$ $V_{GS} = 10V, I_D = 2A$ $V_{GS} = 10V, I_D = 1.5A$	n-ch p-ch n-ch p-ch		0.045 0.100 0.050 0.130	0.055 0.120 0.065 0.160	Ω Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 30 \text{ V}, I_{D} = 2A$ $V_{DS} = 10 \text{ V}, I_{D} = 3A$	n-ch p-ch		7 7.2		S S
C _{iss}	Input capacitance		n-ch p-ch		1030 630		pF pF
C _{oss}	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz},$ $V_{GS} = 0$	n-ch p-ch		140 121		pF pF
C _{rss}	Reverse transfer capacitance		n-ch p-ch		40 49		pF pF
Qg	Total gate charge	N-channel V _{DD} =48V I _D 4A	n-ch p-ch		15 11.6	20.4 15.7	nC nC
Q _{gs}	Gate-source charge	V_{GS} =4.5V P-channel V_{DD} = 48V I_D = 3A	n-ch p-ch		4 4.5		nC nC
Q_{gd}	Gate-drain charge	V _{GS} = 4.5V (see Figure 26)	n-ch p-ch		4 4.7		nC nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
		N-channel					
		$V_{DD} = 30 \text{ V}, I_{D} = 2\text{A}$	n-ch		15		ns
	Turn on doloy time	$R_G=4.7 \Omega, V_{GS}=4.5V$	p-ch		124		ns
^t d(on)	Turn-on delay time Rise time	P-channel					
t _r	nise ume	$V_{DD} = 30 \text{ V}, I_{D} = 1.5 \text{ A}$	n-ch		28		ns
		R_{G} =4.7 Ω , V_{GS} = 4.5 V	p-ch		54		ns
		(see Figure 25)					
		N-channel					
	_ "	$V_{DD} = 30 \text{ V}, I_{D} = 2\text{A}$	n-ch		45		ns
		$R_G=4.7 \Omega, V_{GS}=4.5V$	p-ch		39		ns
t _{d(off)}	Turn-off delay time Fall time	P-channel					
t _f	raii tiirie	$V_{DD} = 30 \text{ V}, I_{D} = 1.5 \text{ A}$	n-ch		10		ns
		$R_G=4.7 \Omega, V_{GS}=4.5V$	p-ch		14.5		ns
		(see Figure 25)					

Table 6. Source drain diode

Symbol	Parameter	Test conditions		Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		n-ch p-ch			4 3	A A
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		n-ch p-ch			16 12	A A
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 4A, V_{GS} = 0$ $I_{SD} = 3A, V_{GS} = 0$	n-ch p-ch			1.2 1.2	V V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	N-channel $I_{SD} = 4A$, di/dt = 100A/μs $V_{DD} = 20 \text{ V,T}_j = 150 \text{ °C}$ P-channel $I_{SD} = 3A$, di/dt = 100A/μs $V_{DD} = 20 \text{ V,T}_j = 150 \text{ °C}$ (see Figure 27)	n-ch p-ch n-ch p-ch n-ch		85 44 85 68.2 2 3.1		ns ns nC nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STS4C3F60L

2.1 Electrical characteristics (curves)

Figure 1. Safe operating n-ch

Figure 2. Thermal impedance for complementary pair

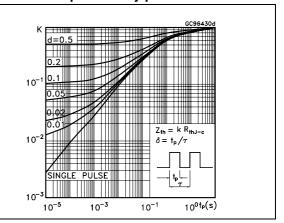
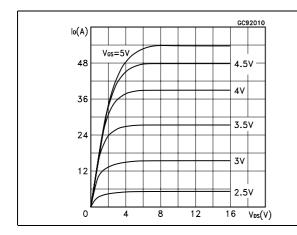


Figure 3. Output characteristics n-ch

Figure 4. Transfer characteristics n-ch



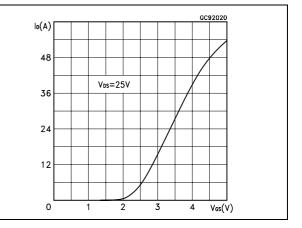
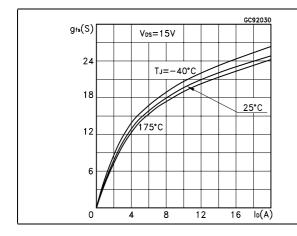
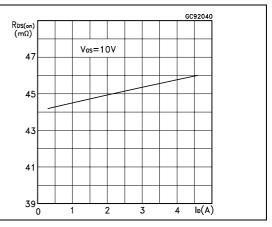


Figure 5. Transconductance n-ch

Figure 6. Static drain-source on resistance n-





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Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations n-ch n-ch

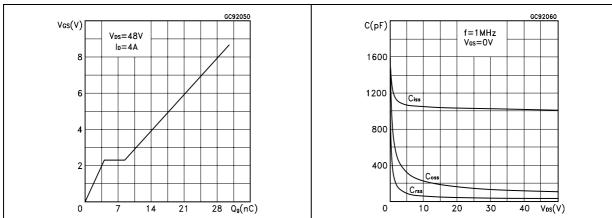


Figure 9. Normalized gate threshold voltage vs. temperature n-ch

Figure 10. Normalized on resistance vs. temperature n-ch

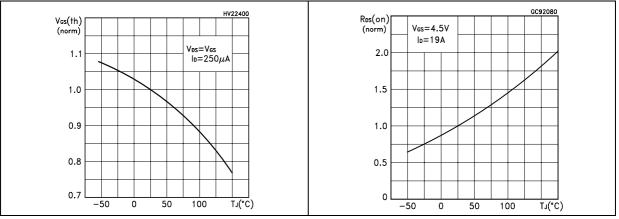
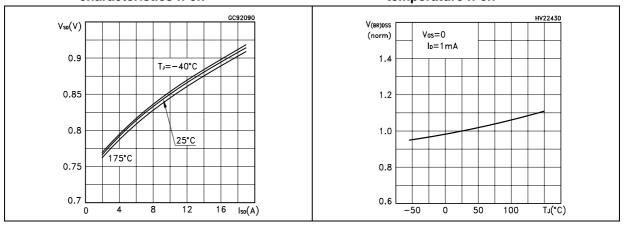


Figure 11. Source-drain diode forward characteristics n-ch

Figure 12. Normalized breakdown voltage vs. temperature n-ch



Electrical characteristics STS4C3F60L

Figure 13. Safe operating p-ch

HV22590

HV22590

10(A)

101

102

103

104

2

105

115

100ms

4

2

10-2

2 4 5 8 2 4 5 8 2 4 5 8 3 4 5 8

Figure 14. Thermal impedance p-ch

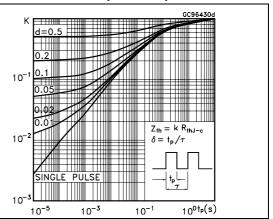
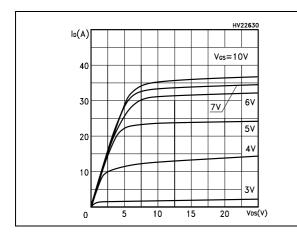


Figure 15. Output characteristics p-ch

Figure 16. Transfer characteristics p-ch



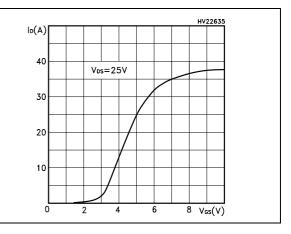
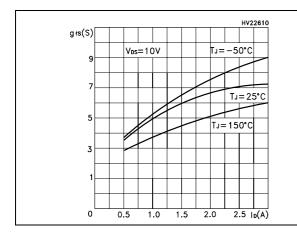


Figure 17. Transconductance p-ch

Figure 18. Static drain-source on resistance p-



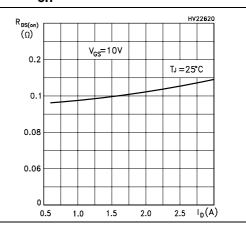


Figure 19. Gate charge vs. gate-source voltage Figure 20. Capacitance variations p-ch p-ch

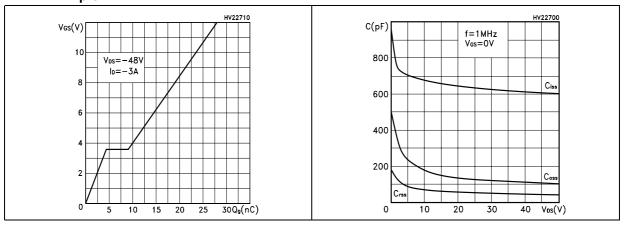


Figure 21. Normalized gate threshold voltage vs. temperature p-ch

Figure 22. Normalized on resistance vs. temperature p-ch

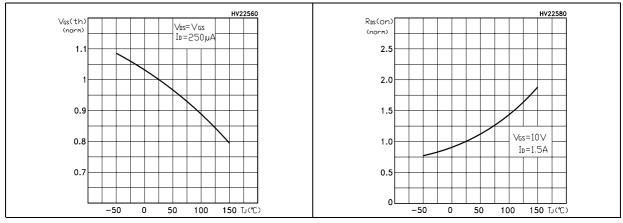
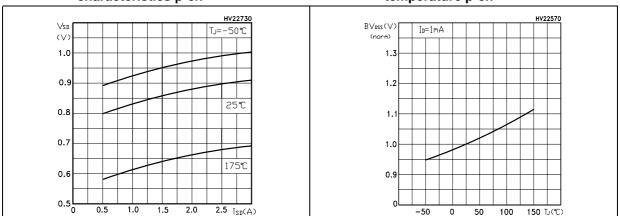


Figure 23. Source-drain diode forward characteristics p-ch

Figure 24. Normalized breakdown voltage vs. temperature p-ch



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Test circuit STS4C3F60L

3 Test circuit

Figure 25. Switching times test circuit for resistive load

Figure 26. Gate charge test circuit

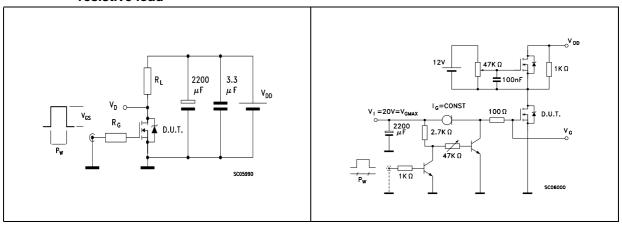


Figure 27. Test circuit for inductive load switching and diode recovery times

Figure 28. Unclamped Inductive load test circuit

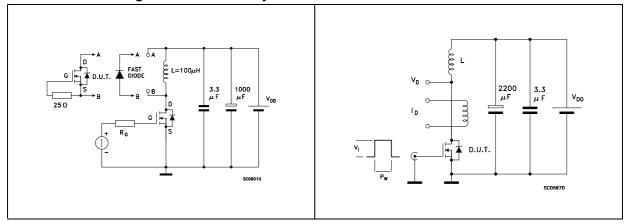
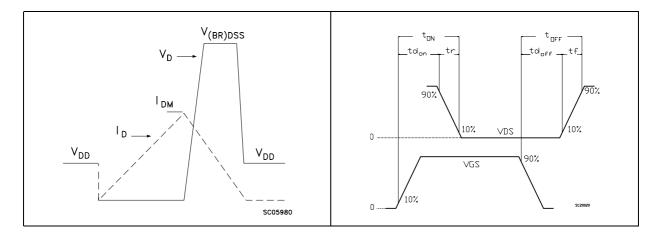


Figure 29. Unclamped inductive waveform

Figure 30. Switching time waveform

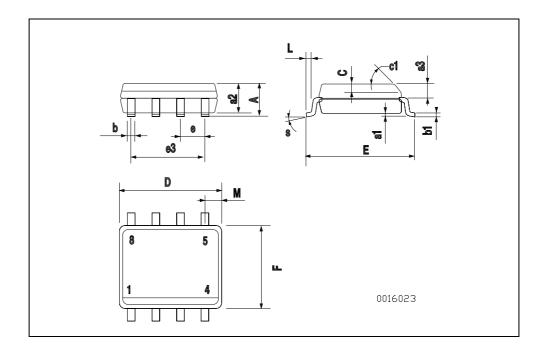


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

SO-8	MECHANICAL	$D\Delta T\Delta$
30-0		. レヘιヘ

DIM.	mm.					
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S			8 (1	max.)	•	•



STS4C3F60L Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
28-Sep-2004	1	First release
13-Nov-2006	2	The document has been reformatted
26-Jan-2007	3	Typo mistake on <i>Table 1</i> .

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